



Mag Layers USA, INC

Specification Sheet

P/N : GMLB-201209-0150A-N8-RU

Products:

[Molded Power Chokes](#)

[Multilayer Chip Inductors](#)

[Lan Transformer](#)

[RF Passive / Antennas](#)

[Automotive](#)

Certifications:

[ISO9001](#)

[IATF16949](#)

[ISO14001](#)

[QC080000](#)

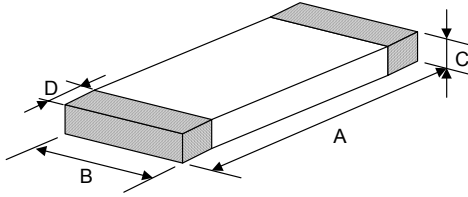
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Contact Us

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PRODUCT DIMENSION

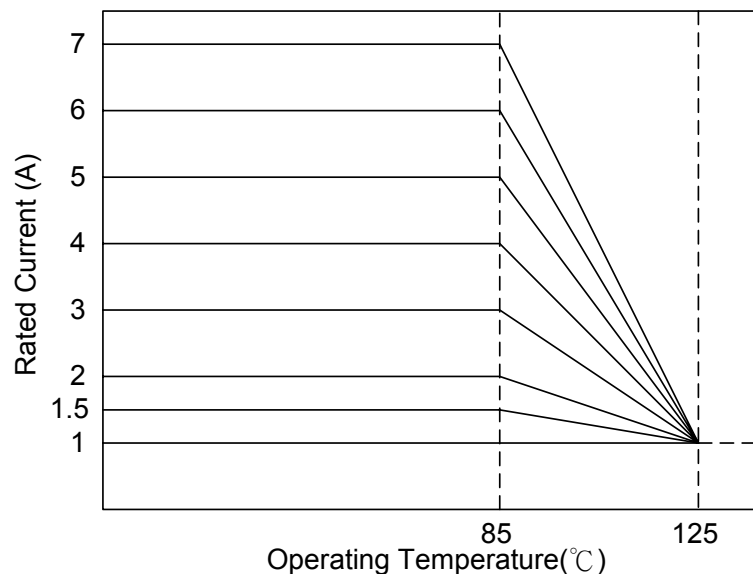


NOTE : Dimensions in mm

PRODUCT NO.	A	B	C	D
GMLB-453215 (1812)	4.5±0.20 (0.177±0.008)	3.2±0.20 (0.126±0.008)	1.5±0.20 (0.059±0.008)	0.5±0.30 (0.020±0.012)
GMLB-451616 (1806)	4.5±0.20 (0.177±0.008)	1.6±0.20 (0.063±0.008)	1.6±0.20 (0.063±0.008)	0.5±0.30 (0.020±0.012)
GMLB-322513 (1210)	3.2±0.20 (0.126±0.008)	2.5±0.20 (0.098±0.008)	1.3±0.20 (0.051±0.008)	0.5±0.30 (0.020±0.012)
GMLB-321616 (1206)	3.2±0.20 (0.126±0.008)	1.6±0.20 (0.063±0.008)	1.6±0.20 (0.063±0.008)	0.5±0.30 (0.020±0.012)
GMLB-321611 (1206)	3.2±0.20 (0.126±0.008)	1.6±0.20 (0.063±0.008)	1.1±0.20 (0.043±0.008)	0.5±0.30 (0.020±0.012)
GMLB-201209 (0805)	2.0±0.20 (0.079±0.008)	1.2±0.20 (0.047±0.008)	0.9±0.20 (0.035±0.008)	0.5±0.30 (0.020±0.012)
GMLB-160808 (0603)	1.6±0.15 (0.063±0.006)	0.8±0.15 (0.031±0.006)	0.8±0.15 (0.031±0.006)	0.3±0.20 (0.012±0.008)

CURRENT DERATING

In operating temperatures exceeding +85°C, derating of current is necessary for chip ferrite beads for which rated current is 1.5A or over. Please apply the derating curve shown below according to the operating temperature.



ELECTRICAL REQUIREMENTS

Part Number	Impedance (Ω) at 100 MHz	R_{DC} (Ω) Max.	Rated Current (mA) Max.	Operating Temp. Range ($^{\circ}\text{C}$)
GMLB-201209-0150A-N8-RU	150 \pm 25%	0.3	300	-55 ~ +125

- Temperature rise should be less than 40 $^{\circ}\text{C}$ for P-type and less than 25 $^{\circ}\text{C}$ for other types when rated current is applied.

MEASURING METHOD / CONDITION

- Test Instrument:

Z: Agilent 4291B Impedance Analyzer, Test Fixture: Agilent 16192

Osc. Level: 500mV

R_{DC} : Agilent 34401A

- Test Condition:

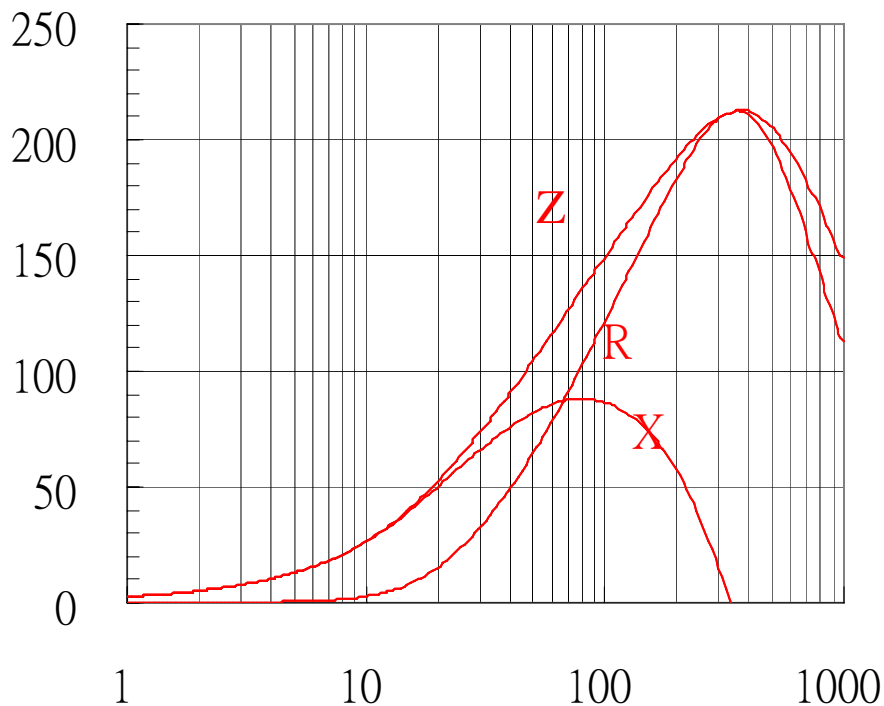
< Unless otherwise specified >

Temperature: 15 $^{\circ}\text{C}$ to 35 $^{\circ}\text{C}$ Humidity: 25% to 85% RH

< In case of doubt >

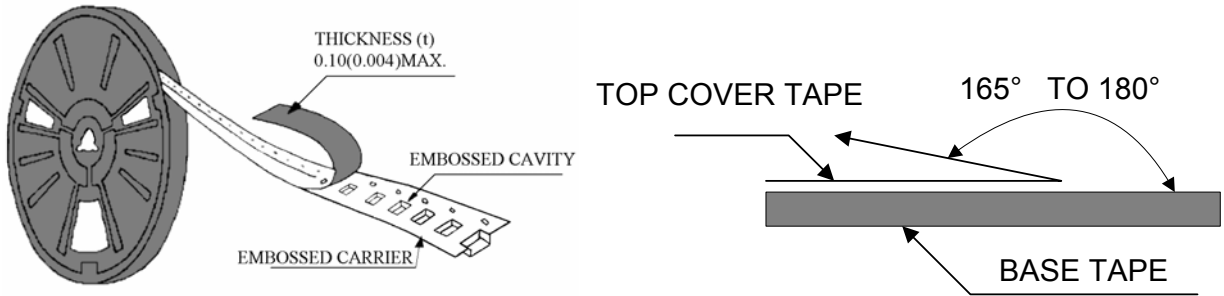
Temperature: 25 $^{\circ}\text{C} \pm 2^{\circ}\text{C}$ Humidity: 60% to 70% RH

ELECTRICAL CHARACTERISTICS (T=25 $^{\circ}\text{C}$)



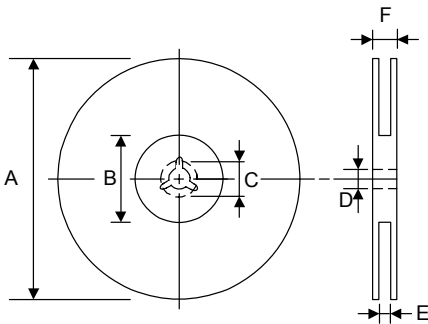
PACKAGING

● Peel-off Force

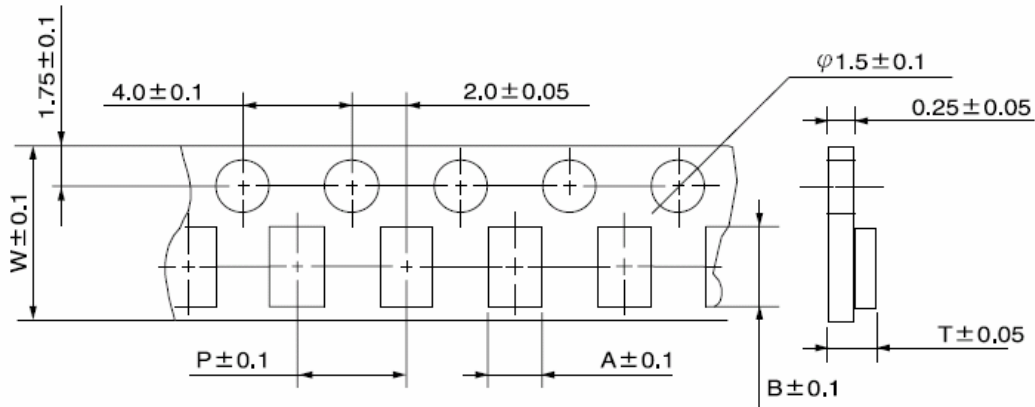


The force for peeling off cover tape is 10 grams in the arrow direction.

● Dimension (Unit: mm)

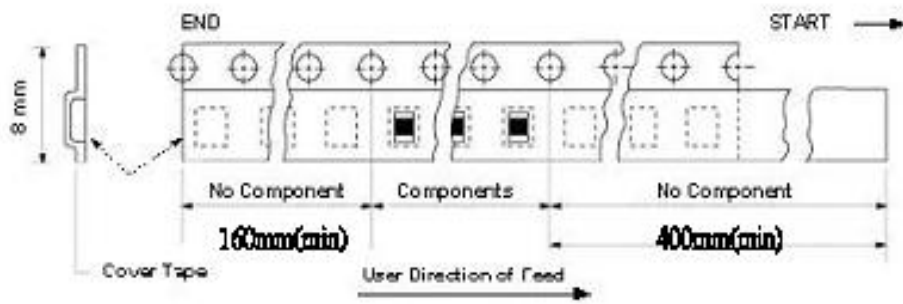


TYPE	A	B	C	D	E	F
8 mm	178±1	60 +0.5 -0	-	13 ±0.2	9 ±0.5	12 ±0.5
12 mm	178±0.3	60 ±0.2	19.3 ±0.1	13.5 ±0.1	13.6 ±0.1	-



TYPE	SIZE	A	B	W	P			CHIPS/REEL
GMLB	160808	1.1	1.9	8	4	1.1,	*0.95±0.05	4000
	201209	1.5	2.3	8	4	1.3,	*0.95±0.10	4000
	321611	1.9	3.5	8	4	1.5		3000
	321616	1.9	3.5	8	4	2.0		3000
	322513	2.9	3.6	8	4	1.7		2500
	451616	1.9	4.9	12	4	2.0		2000
	453215	3.6	4.9	12	8	1.9		1000

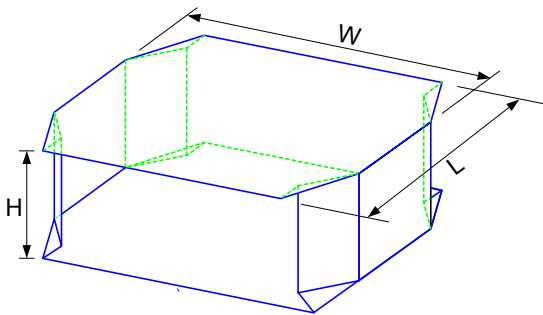
*: For paper reels



● Taping Quantity

SERIES	4532	4516	3225	3216	2012	1608
PCS/Reel	1000	2000	2500	3000	4000	4000

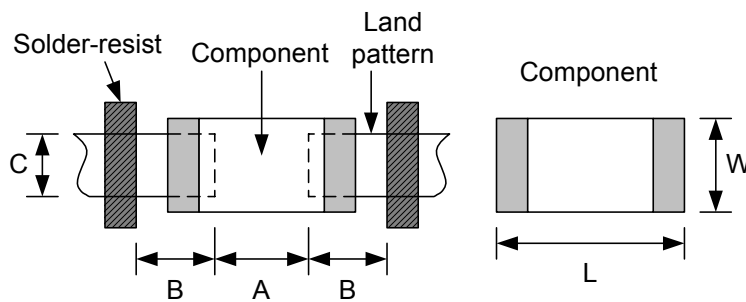
● Tape Packing Case



No. of Reels	W	L	H
2	18±0.5	18±0.5	2.4±0.2
3	18±0.5	18±0.5	3.6±0.2
4	18±0.5	18±0.5	4.8±0.2
5	18±0.5	18±0.5	6.0±0.2

Unit: cm

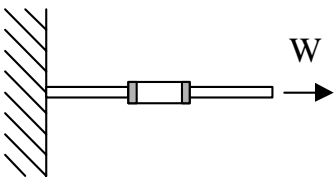
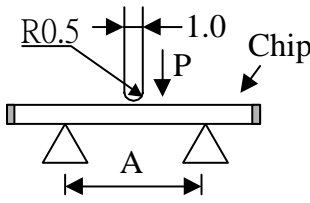
■ RECOMMENDED PCB LAYOUT



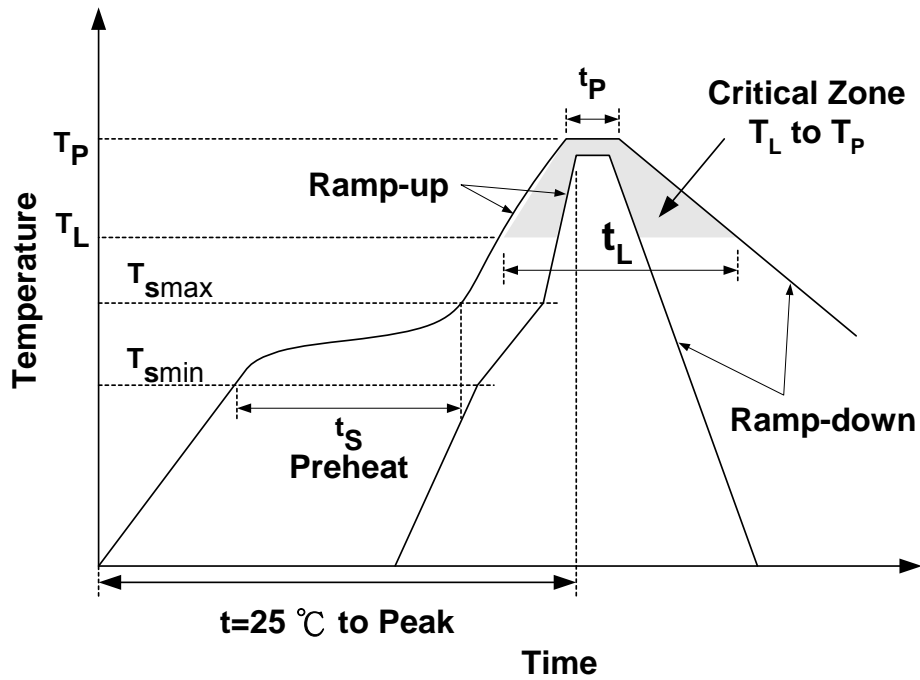
Unit: mm

Type	1608	2012	3216	3225	4516	4532	
Size	L	1.6	2.0	3.2	3.2	4.5	4.5
	W	0.8	1.2	1.6	2.5	1.6	3.2
A	0.6~0.8	0.8~1.2	1.8~2.2	1.8~2.2	3.4	3.4	
B	0.6~0.8	0.8~1.2	1.1~1.6	1.1~1.6	1.5	1.5	
C	0.6~0.8	0.9~1.6	0.9~1.6	3.40	1.4	4.2	

RELIABILITY TEST

•Mechanical Performance Test				
ITEM	SPECIFICATION	TEST CONDITION		
Solderability	More than 90% of the terminal electrode shall be covered with fresh solder.	Solder: 96.5Sn-3.0Ag-0.5Cu Solder Temperature: 245 ± 5°C Flux: Rosin Dip Time: 3 ± 1 Seconds		
Soldering Heat Resistance	The chip shall not crack. More than 75% of the terminal electrode shall be covered with solder.	Solder: 96.5Sn-3.0Ag-0.5Cu Solder temperature : 260 ± 5°C Flux: Rosin Dip time: 10 ± 1 seconds		
Terminal Strength	The terminal electrode shall not be broken off nor the ferrite damaged. 	TYPE	W(KGF)	TIME (SEC)
		GMLB-160808	0.6	
		GMLB-201209		
		GMLB-321611	1.0	
		GMLB-321616		
		GMLB-322513		
		GMLB-451616		
GMLB-453215	1.5			
Bending Strength	No mechanical damage. The ferrite shall not be damaged. 	TYPE	A(MM)	P(KGF)
		GMLB-160808	1.0	1.0
		GMLB-201209	1.4	
		GMLB-321611	2.0	2.0
		GMLB-321616		
		GMLB-322513		
		GMLB-451616	2.5	2.5
GMLB-453215	2.7			
• Climatic test				
ITEM	SPECIFICATION	TEST CONDITION		
Thermal Shock (Temperature Cycle)	Impedance shall be within ± 20% of the initial value.	Temperature cycle : -55°C~125°C for 30 minutes each. Total: 100 cycles.		
Humidity Resistance		Temperature : +60°C Humidity: 90% RH Applied current: rated current Time: 1000 ± 12 hours		
High Temperature Resistance		Temperature : 80°C Applied current: rated current Time: 1000 ± 12 hours		
1. Operating Temperature Range: -55 °C TO +125°C 2. Storage Condition: The temperature should be within -40°C~85°C and humidity should be less than 75% RH. The product should be used within 6 months from the time of delivery.				

RECOMMENDED REFLOW SOLDERING PROFILE



Profile Feature		Sn-Pb	Pb-Free
Preheat	t_s	60~120 seconds	60~180 seconds
	T_{smin}	100°C	150°C
	T_{smax}	150°C	200°C
Average ramp-up rate (T_{smax} to T_P)		3°C/second max.	3°C/second max.
Time main above	Temperature (T_L)	183°C	217°C
	Time (t_L)	60~150 seconds	60~150 seconds
Peak temperature (T_P)		230°C	250~260°C
Time within 5°C of actual peak temperature (t_p)		10 seconds	10 seconds
Ramp-down rate		6°C/sec max.	6°C/sec max.
Time 25°C to peak temperature		6 minutes max.	8 minutes max.

NOTES

The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.